- 3-State Outputs Drive Bus Lines or Buffer Memory Address Registers
- Data Flow-Through Pinout (All Inputs on Opposite Side From Outputs)
- Package Options Include Plastic Small-Outline Packages, Ceramic Chip Carriers, and Plastic and Ceramic DIPs


## description

The'F541 octal buffer/line driver is ideal for driving bus lines or buffering memory address registers. The device features inputs and outputs on opposite sides of the package to facilitate printed-circuit-board layout.
The 3-state control gate is a 2 -input AND gate with active-low inputs so that if either output enable ( $\overline{\mathrm{OE} 1}$ or $\overline{\mathrm{OE} 2}$ ) input is high, all eight outputs are in the high-impedance state.
The SN54F541 is characterized for operation over the full military temperature range of $-55^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$. The SN74F251 is characterized for operation from $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$.

SN54F541 . . . J PACKAGE SN74F541 ... DW OR N PACKAGE (TOP VIEW)

| OE1 | 1 |  | 20 | $\mathrm{V}_{\mathrm{CC}}$ |
| :---: | :---: | :---: | :---: | :---: |
| A1 | 2 | 1 | 19 | OE2 |
| A2 | 3 |  | 18 | Y1 |
| A3 | 4 |  | 17 | Y2 |
| A4 | 5 | 1 | 16 | Y3 |
| A5 | 6 |  | 15 | Y4 |
| A6 | 7 |  | 14 | Y5 |
| A7 | 8 |  | 13 | Y6 |
| A8 | 9 |  | 12 | Y7 |
| GND | 10 |  | 11 | Y8 | (TOP VIEW)



FUNCTION TABLE

| INPUTS |  |  | OUTPUT |
| :---: | :---: | :---: | :---: |
| $\overline{\text { OE1 }}$ | $\overline{\text { OE2 }}$ | A | Y |
| L | L | L | L |
| L | L | $H$ | $H$ |
| $H$ | $X$ | $X$ | $Z$ |
| $X$ | $H$ | $X$ | $Z$ |

## logic symbol $\dagger$


† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

## logic diagram (positive logic)



To Seven Other Channels
absolute maximum ratings over operating free-air temperature range (unless otherwise noted) $\ddagger$

Input voltage range, $\mathrm{V}_{\mathrm{I}}$ (see Note 1) ............................................................. -1.2 V to 7 V
Input current range ....................................................................... -30 mA to 5 mA
Voltage range applied to any output in the disabled or power-off state $\ldots \ldots . . . . . . . . .$.

Current into any output in the low state: SN54F541 ................................................... 96 mA
SN74F541 ................................................... 128 mA
SN54F541 .............................................. $-55^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$
SN74F541 ............................................. $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$
Storage temperature range
$-65^{\circ} \mathrm{C}$ to $150^{\circ} \mathrm{C}$
$\ddagger$ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
NOTE 1: The input voltage ratings may be exceeded provided the input current ratings are observed.
recommended operating conditions

|  |  |  | 54F5 |  |  | 74F54 |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | NOM | MAX | MIN | NOM | MAX |  |
| $\mathrm{V}_{\mathrm{CC}}$ | Supply voltage | 4.5 | 5 | 5.5 | 4.5 | 5 | 5.5 | V |
| $\mathrm{V}_{\mathrm{IH}}$ | High-level input voltage | 2 |  |  | 2 |  |  | V |
| VIL | Low-level input voltage |  |  | 0.8 |  |  | 0.8 | V |
| IIK | Input clamp current |  |  | -18 |  |  | -18 | mA |
| IOH | High-level output current |  |  | -12 |  |  | -15 | mA |
| $\mathrm{IOL}^{\text {I }}$ | Low-level output current |  |  | 48 |  |  | 64 | mA |
| $\mathrm{T}_{\text {A }}$ | Operating free-air temperature | -55 |  | 125 | 0 |  | 70 | ${ }^{\circ} \mathrm{C}$ |

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS |  | SN54F541 |  |  | SN74F541 |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP† | MAX | MIN | TYP $\dagger$ | MAX |  |
| $\mathrm{V}_{\text {IK }}$ | $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$, | $\boldsymbol{I}=-18 \mathrm{~mA}$ |  |  | -1.2 |  |  | -1.2 | V |
| $\mathrm{V}_{\mathrm{OH}}$ | $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$ | $\mathrm{IOH}=-3 \mathrm{~mA}$ | 2.4 | 3.3 |  | 2.4 | 3.3 |  | V |
|  |  | $\mathrm{IOH}=-12 \mathrm{~mA}$ | 2 | 3.2 |  |  |  |  |  |
|  |  | $1 \mathrm{OH}=-15 \mathrm{~mA}$ |  |  |  | 2 | 3.1 |  |  |
|  | $\mathrm{V}_{\mathrm{CC}}=4.75 \mathrm{~V}$, | $\mathrm{IOH}=-3 \mathrm{~mA}$ |  |  |  | 2.7 |  |  |  |
| VOL | $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$ | $\mathrm{IOL}=48 \mathrm{~mA}$ |  | 0.38 | 0.55 |  |  |  | V |
|  |  | $\mathrm{IOL}=64 \mathrm{~mA}$ |  |  |  |  | 0.42 | 0.55 |  |
| IOZH | $\mathrm{V}_{\mathrm{CC}}=5.5 \mathrm{~V}$, | $\mathrm{V}_{\mathrm{O}}=2.7 \mathrm{~V}$ |  |  | 50 |  |  | 50 | $\mu \mathrm{A}$ |
| IOZL | $\mathrm{V}_{\mathrm{CC}}=5.5 \mathrm{~V}$, | $\mathrm{V}_{\mathrm{O}}=0.5 \mathrm{~V}$ |  |  | -50 |  |  | -50 | $\mu \mathrm{A}$ |
| I | $\mathrm{V}_{\mathrm{CC}}=5.5 \mathrm{~V}$, | $\mathrm{V}_{\mathrm{I}}=7 \mathrm{~V}$ |  |  | 0.1 |  |  | 0.1 | mA |
| IIH | $\mathrm{V}_{\mathrm{CC}}=5.5 \mathrm{~V}$, | $\mathrm{V}_{1}=2.7 \mathrm{~V}$ |  |  | 20 |  |  | 20 | $\mu \mathrm{A}$ |
| IIL | $\mathrm{V}_{\mathrm{CC}}=5.5 \mathrm{~V}$, | $\mathrm{V}_{1}=0.5 \mathrm{~V}$ |  |  | -0.6 |  |  | -0.6 | mA |
| los ${ }^{\ddagger}$ | $\mathrm{V}_{\mathrm{CC}}=5.5 \mathrm{~V}$, | $\mathrm{V}_{\mathrm{O}}=0$ | -100 |  | -225 | -100 |  | -225 | mA |
| ${ }^{\text {I CC }}$ | $\mathrm{V}_{\mathrm{CC}}=5.5 \mathrm{~V}$ | Outputs high |  | 28 | 35 |  | 28 | 35 | mA |
|  |  | Outputs low |  | 62 | 75 |  | 62 | 75 |  |
|  |  | Outputs disabled |  | 40 | 55 |  | 40 | 55 |  |

$\dagger$ All typical values are at $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
$\ddagger$ Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed one second.

## switching characteristics (see Note 2)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | $\begin{aligned} & \mathrm{V}_{\mathrm{C}}=5 \mathrm{~V}, \\ & \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}, \\ & \mathrm{R}_{\mathrm{L}}=500 \Omega, \\ & \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C} \end{aligned}$ |  |  | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V} \text { to } 5.5 \mathrm{~V}, \\ & \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}, \\ & \mathrm{R}_{\mathrm{L}}=500 \Omega, \\ & \mathrm{~T}_{\mathrm{A}}=\mathrm{MIN} \text { to MAX§ } \end{aligned}$ |  |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | 'F541 |  |  | SN54F541 |  | SN74F541 |  |  |
|  |  |  | MIN | TYP | MAX | MIN | MAX | MIN | MAX |  |
| tPLH | Any A | Y | 1.5 | 3.3 | 5.5 | 1 | 6.5 | 1.5 | 6 | ns |
| tPHL |  |  | 1.5 | 2.7 | 5.5 | 1 | 6.5 | 1.5 | 6 |  |
| tPZH | $\overline{\mathrm{OE}}$ | Y | 3 | 5.8 | 8 | 1.7 | 10 | 2.5 | 9.5 | ns |
| tPZL |  |  | 3.5 | 6.1 | 8.5 | 2.2 | 10 | 3 | 9.5 |  |
| tPHZ | OE | Y | 1.5 | 3.4 | 6 | 1 | 7 | 1.5 | 6.5 | ns |
| tplZ |  |  | 1.5 | 2.9 | 5.5 | 1 | 7.5 | 1.5 | 6 |  |

§ For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
NOTE 2: Load circuits and waveforms are shown in Section 1.

## PACKAGING INFORMATION

| Orderable Device | Status ${ }^{(1)}$ | Package Type | Package Drawing | Pins | Package Qty | $\text { Eco Plan }{ }^{(2)}$ | Lead/Ball Finish | MSL Peak Temp ${ }^{(3)}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 5962-9175301M2A | ACTIVE | LCCC | FK | 20 | 1 | TBD | Call TI | Level-NC-NC-NC |
| 5962-9175301MRA | ACTIVE | CDIP | J | 20 | 1 | TBD | Call TI | Level-NC-NC-NC |
| 5962-9175301MSA | ACTIVE | CFP | W | 20 | 1 | TBD | Call TI | Level-NC-NC-NC |
| SN74F541DBRE4 | ACTIVE | SSOP | DB | 20 | 2000 | Pb-Free (RoHS) | CU NIPDAU | Level-2-260C-1 YEAR/ Level-1-235C-UNLIM |
| SN74F541DBRG4 | ACTIVE | SSOP | DB | 20 | 2000 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br} \text { ) } \end{gathered}$ | CU NIPDAU | Level-2-260C-1YEAR |
| SN74F541DW | ACTIVE | SOIC | DW | 20 | 25 | Pb-Free (RoHS) | CU NIPDAU | Level-2-250C-1 YEAR/ Level-1-235C-UNLIM |
| SN74F541DWE4 | ACTIVE | SOIC | DW | 20 | 25 | Pb-Free (RoHS) | CU NIPDAU | Level-2-250C-1 YEAR/ Level-1-235C-UNLIM |
| SN74F541DWR | ACTIVE | SOIC | DW | 20 | 2000 | Pb-Free (RoHS) | CU NIPDAU | Level-2-250C-1 YEAR/ Level-1-235C-UNLIM |
| SN74F541DWRE4 | ACTIVE | SOIC | DW | 20 | 2000 | Pb-Free (RoHS) | CU NIPDAU | Level-2-250C-1 YEAR/ Level-1-235C-UNLIM |
| SN74F541N | ACTIVE | PDIP | N | 20 | 20 | Pb-Free (RoHS) | CU NIPDAU | Level-NC-NC-NC |
| SN74F541NE4 | ACTIVE | PDIP | N | 20 | 20 | Pb-Free (RoHS) | CU NIPDAU | Level-NC-NC-NC |
| SN74F541NSR | ACTIVE | SO | NS | 20 | 2000 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no Sb/Br) } \\ \hline \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| SN74F541NSRE4 | ACTIVE | SO | NS | 20 | 2000 | Green (RoHS \& no $\mathrm{Sb} / \mathrm{Br}$ ) | CU NIPDAU | Level-1-260C-UNLIM |
| SNJ54F541FK | ACTIVE | LCCC | FK | 20 | 1 | TBD | Call TI | Level-NC-NC-NC |
| SNJ54F541J | ACTIVE | CDIP | J | 20 | 1 | TBD | Call TI | Level-NC-NC-NC |
| SNJ54F541W | ACTIVE | CFP | W | 20 | 1 | TBD | Call TI | Level-NC-NC-NC |

${ }^{(1)}$ The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but Tl does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.
${ }^{(2)}$ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS \& no $\mathrm{Sb} / \mathrm{Br}$ ) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.
TBD: The $\mathrm{Pb}-\mathrm{Free} / \mathrm{Green}$ conversion plan has not been defined.
Pb -Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed $0.1 \%$ by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.
Green (RoHS \& no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants ( Br or Sb do not exceed $0.1 \%$ by weight in homogeneous material)
${ }^{(3)}$ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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## PACKAGE OPTION ADDENDUM

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| DIM PINS ** | 14 | 16 | 18 | 20 |
| :---: | :---: | :---: | :---: | :---: |
| A | 0.300 <br> $(7,62)$ <br> BSC | 0.300 <br> $(7,62)$ <br> BSC | 0.300 <br> $(7,62)$ <br> BSC | 0.300 <br> $(7,62)$ <br> BSC |
| B MAX | 0.785 <br> $(19,94)$ | .840 <br> $(21,34)$ | 0.960 <br> $(24,38)$ | 1.060 <br> $(26,92)$ |
| B MIN | - | - | - | - |
| C MAX | 0.300 <br> $(7,62)$ | 0.300 <br> $(7,62)$ | 0.310 <br> $(7,87)$ | 0.300 <br> $(7,62)$ |
| C MIN | 0.245 <br> $(6,22)$ | 0.245 <br> $(6,22)$ | 0.220 <br> $(5,59)$ | 0.245 <br> $(6,22)$ |



NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package is hermetically sealed with a ceramic lid using glass frit.
D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

W (R-GDFP-F20)


4040180-4/D 07/03
NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package can be hermetically sealed with a ceramic lid using glass frit.
D. Index point is provided on cap for terminal identification only.
E. Falls within Mil-Std 1835 GDFP2-F20

FK (S-CQCC-N**)


NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package can be hermetically sealed with a metal lid.
D. The terminals are gold plated.
E. Falls within JEDEC MS-004

N (R-PDIP-T**)
PLASTIC DUAL-IN-LINE PACKAGE
16 PINS SHOWN


NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C) Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).

D The 20 pin end lead shoulder width is a vendor option, either half or full width.

DW (R-PDSO-G2O)

## PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion not to exceed $0.006(0,15)$.
D. Falls within JEDEC MS-013 variation AC.

NS (R-PDSO-G**)
14-PINS SHOWN


| DIM PINS ** | 14 | 16 | 20 | 24 |
| :---: | :---: | :---: | :---: | :---: |
| A MAX | 10,50 | 10,50 | 12,90 | 15,30 |
| A MIN | 9,90 | 9,90 | 12,30 | 14,70 |

NOTES: A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.


| DIM PINS ** | $\mathbf{1 4}$ | $\mathbf{1 6}$ | $\mathbf{2 0}$ | $\mathbf{2 4}$ | $\mathbf{2 8}$ | $\mathbf{3 0}$ | $\mathbf{3 8}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| A MAX | 6,50 | 6,50 | 7,50 | 8,50 | 10,50 | 10,50 | 12,90 |
| A MIN | 5,90 | 5,90 | 6,90 | 7,90 | 9,90 | 9,90 | 12,30 |

NOTES: A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
D. Falls within JEDEC MO-150

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